

In the disclosure:

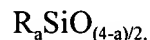
On page 11, line 17, kindly replace "%" with -- percent -- .

In the claims:

Kindly rewrite Claim 1 as follows:

1(once amended). An electrical insulating silicone rubber composition comprising

(A) 100 weight parts polyorganosiloxane comprising at least 2 silicon bonded alkenyl groups in each molecule and having average compositional formula



where R is selected from the group consisting of substituted monovalent hydrocarbon groups and unsubstituted monovalent hydrocarbon groups and a has a value of from 1.95 to 2.05,

(B) 1 to 300 with parts surface-treated aluminum hydroxide powder surface treated with a[n] treating agent selected from the group consisting of organomethoxysilanes, organoethoxysilanes, and [or] organosilazanes, and
(C) an organoperoxide curing agent in a quantity sufficient to cure the composition.

5(once amended). A composition according to Claim 1, where the surface treated

aluminum hydroxide powder is surface treated with an organomethoxysilane or an organoethoxysilane.

6(once amended). A composition according to Claim 5 where the [organosilane is]

surface treated aluminum hydroxide powder is surface treated with

vinyltrimethoxysilane.

7(once amended). A composition according to Claim 5, where the [organosilane is]

surface treated aluminum hydroxide powder is surface treated with

methyltrimethoxysilane.

10(once amended). A composition according to Claim 1 [8], where the surface treated

aluminum hydroxide powder is surface treated with from 0.1 to 30 weight percent

of the treating agent [organosilane or organosilazane].

Kindly cancel claim 11, which is now embodied is Claim 1 (once amended).

Kindly cancel claim 12.

Kindly add the following claim:

15. A composition according to claim 5 where the treating agent is selected from the

group consisting of methyltrimethoxysilane, methyltriethoxysilane,

phenyltrimethoxysilane, ethyltrimethoxysilane, n-propyltrimethoxysilane,

vinyltrimethoxysilane, allyltrimethoxysilane, butenyltrimethoxysilane,

hexenyltrimethoxysilane, γ -methacryoxypropyltrimethoxysilane,

dimethyldimethoxysilane, dimethyldiethoxysilane, diphenyldimethoxysilane, and

tetraethoxysilane.